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(54) Title (EN): SEALANT COMPOSITION

(54) Title (FR): COMPOSITION DE MATÉRIAU D'ÉTANCHÉITÉ

(54) Title (KO): 밀봉재 조성물

(57) Abstract:

(EN): The present application relates to a sealant composition and an organic electronic device comprising same, and provides a sealant composition which can secure the life of an organic electronic device by effectively blocking moisture or oxygen introduced into the organic electronic device from the outside, implement a top emission-type organic electronic device, be applied by an inkjet method, and provide a thin display.

(FR): L'invention concerne une composition de matériau d'étanchéité et un dispositif électronique organique la comprenant. La composition de matériau d'étanchéité selon l'invention peut : garantir la durée de vie d'un dispositif électronique organique par le blocage efficace de l'humidité ou de l'oxygène s'introduisant dans le dispositif électronique organique depuis l'extérieur; mettre en oeuvre un dispositif électronique organique de type à émission par le haut; être appliquée par un procédé à jet d'encre; et fournir un affichage mince.

(KO): 본 출원은 밀봉재 조성물 및 이를 포함하는 유기전자장치에 관한 것으로서, 외부로부터 유기전자장치로 유입되는 수분 또는 산소를 효과적으로 차단하여 유기전자장치의 수명을 확보할 수 있고, 전면 발광형 유기전자장치의 구현이 가능하며, 잉크젯 방식으로 적용 가능하고, 박형의 디스플레이를 제공할 수 있는 밀봉재 조성물을 제공한다.

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